

TMG90N06NF
N-Channel Enhancement Mosfet
General Description

- Low R_{DS(ON)}
- RoHS and Halogen-Free Compliant

Applications

- Load switch
- PWM

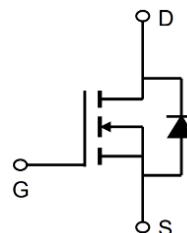
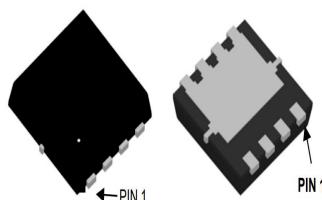
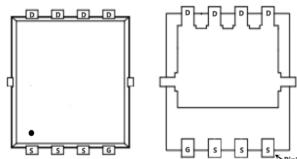
General Features

V_{DS} = 60V I_D = 90A
R_{DS(ON)} = 4.3 mΩ(typ.)@V_{GS}=10V

100% UIS Tested
100% R_g Tested



NF:DFN5x6-8L



Marking: G90N06

Absolute Maximum Ratings: (T_C=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Units
V _{DS}	Drain-Source Voltage	60	V
V _{GS}	Gate-Source Voltage	±20	V
I _D	Continuous Drain Current-TC=25°C ¹	90	A
I _{DM}	Pulsed Drain Current ²	310	
I _{sp}	Pulsed source current	210	A
E _{AS}	Single Pulse Avalanche Energy	66	mJ
P _D	Power Dissipation ³	87	W
I _S	Diode Forward Current	90	A
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 to +150	°C

Thermal Characteristics:

Symbol	Parameter	Max	Units
R _{θJC}	Thermal Resistance,Junction to Case	1.44	°C/W
R _{θJA}	Thermal Resistance Junction to mbient ⁴	62	°C/W

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Electrical Characteristics: ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250 \mu\text{A}$	60	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=60\text{V}$	---	---	1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{A}$	---	---	± 100	nA
On Characteristics						
$V_{\text{GS}(\text{th})}$	GATE-Source Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=250 \mu\text{A}$	1	1.7	2.5	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On Resistance	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=20\text{A}$	---	4.3	5	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=10\text{A}$	---	5.1	7	
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}}=50\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	---	2136	---	pF
C_{oss}	Output Capacitance		---	331.5	---	
C_{rss}	Reverse Transfer Capacitance		---	10.6	---	
Switching Characteristics						
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	$V_{\text{GS}}=10\text{ V}, V_{\text{DS}}=50\text{ V}, R_{\text{G}}=2 \Omega, I_{\text{D}}=25 \text{ A}$	---	22.9	---	ns
t_r	Rise Time		---	6.5	---	ns
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time		---	45.7	---	ns
t_f	Fall Time		---	20.4	---	ns
Q_g	Total Gate Charge	$I_{\text{D}}=25 \text{ A}, V_{\text{DS}}=50 \text{ V}, V_{\text{GS}}=10 \text{ V}$	---	30	---	nC
Q_{gs}	Gate-Source Charge		---	5.8	---	nC
Q_{gd}	Gate-Drain "Miller" Charge		---	6.1	---	nC
Drain-Source Diode Characteristics						
Symbol	Parameter	Conditions	Min	Typ	Max	Units
V_{SD}	Source-Drain Diode Forward Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=20\text{A}$	---		1.3	V
trr	Continuous Source Current	$I_{\text{S}}=25 \text{ A}, \frac{dI}{dt}=100 \text{ A}/\mu\text{s}$	---	50.3	---	ns
qrr	Pulsed Source Current		---	45.1	---	nC

Notes:

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) P_d is based on max. junction temperature, using junction-case thermal resistance.
- 4) $V_{DD}=30 \text{ V}, R_{\text{G}}=25 \Omega, L=0.3 \text{ mH}$, starting $T_j=25^\circ\text{C}$.
- 5) The value of $R_{\theta JA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with $T_a=25^\circ\text{C}$.

Typical Characteristics

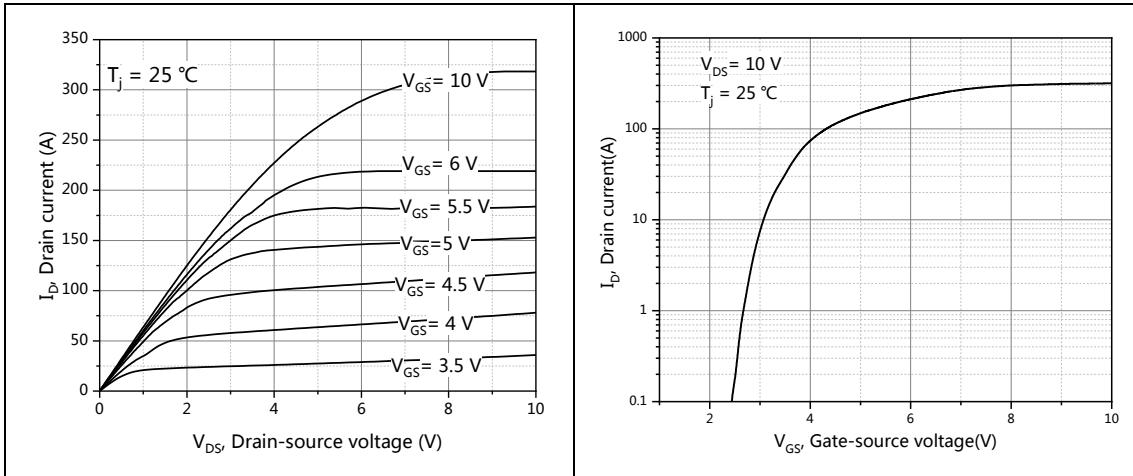


Figure 1, Typ. output characteristics

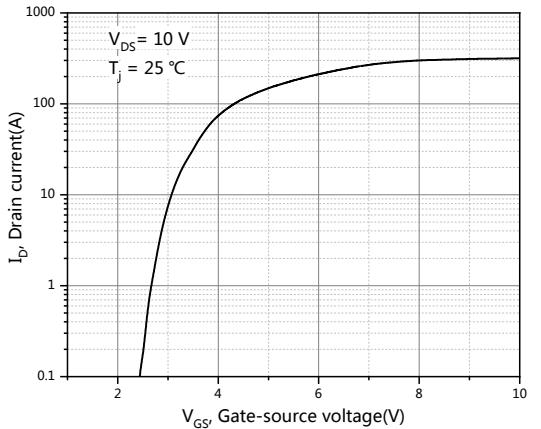


Figure 2, Typ. transfer characteristics

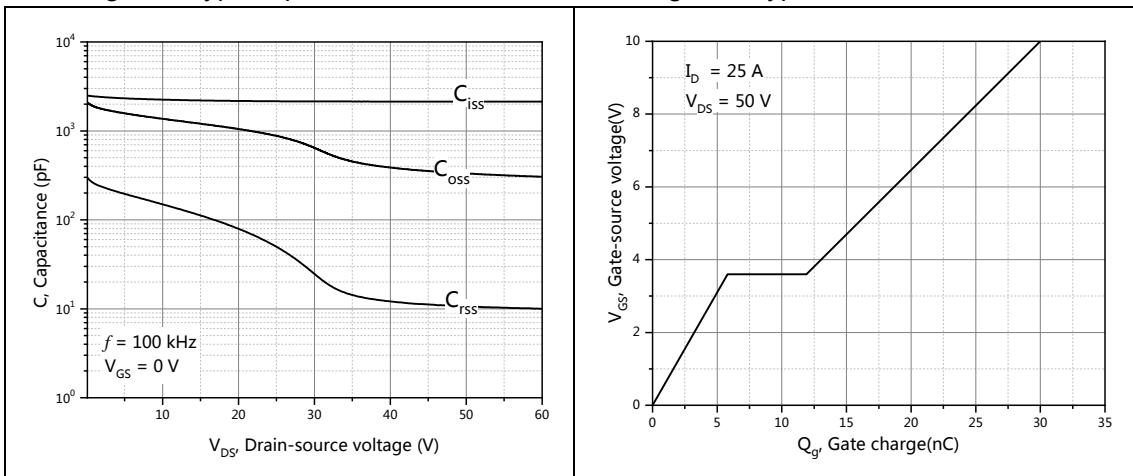


Figure 3, Typ. capacitances

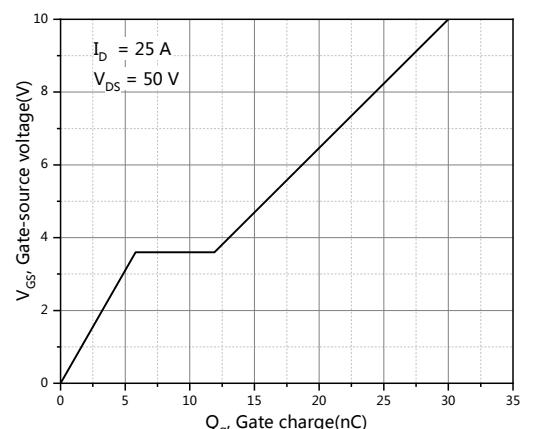


Figure 4, Typ. gate charge

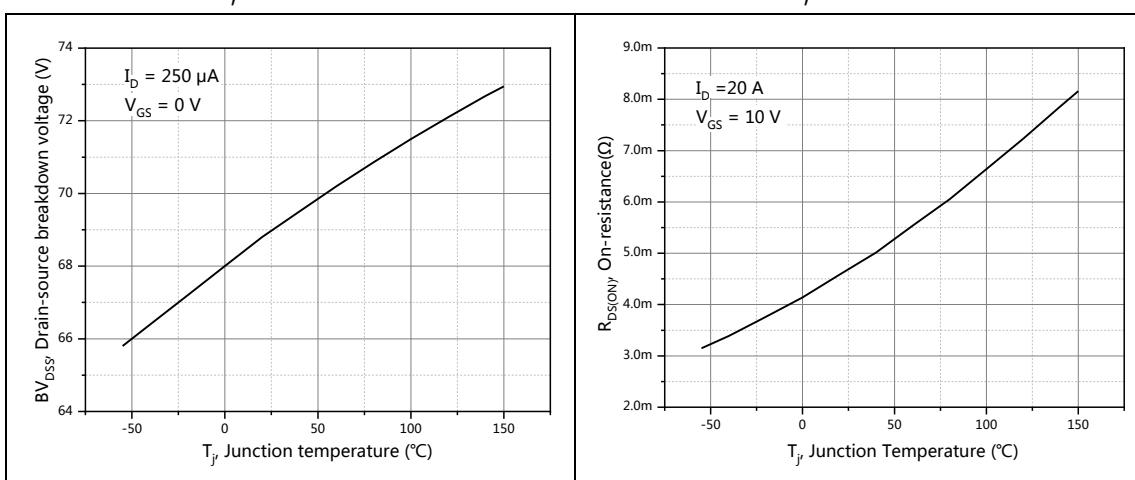


Figure 5, Drain-source breakdown voltage

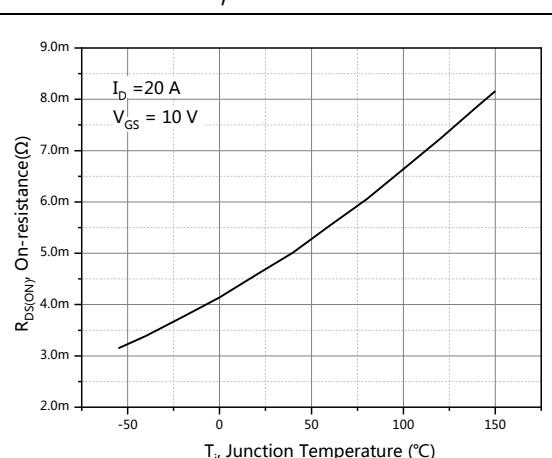


Figure 6, Drain-source on-state resistance

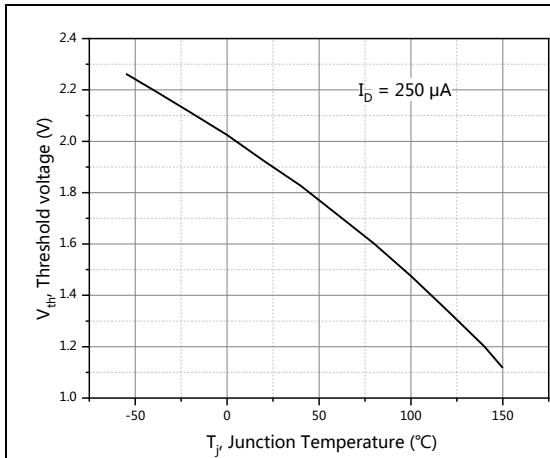


Figure 7, Threshold voltage

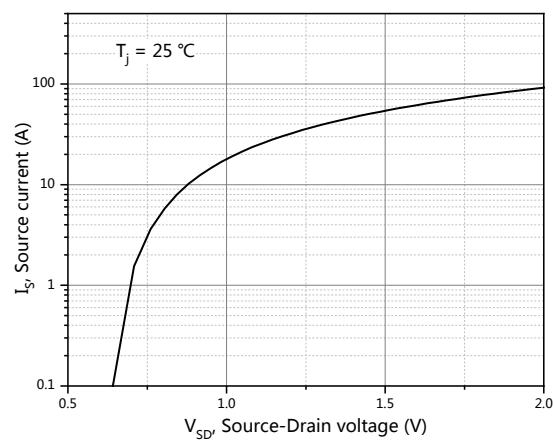


Figure 8, Forward characteristic of body diode

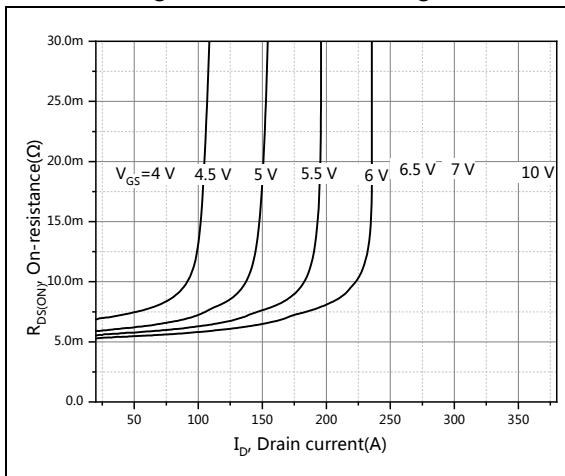


Figure 9, Drain-source on-state resistance

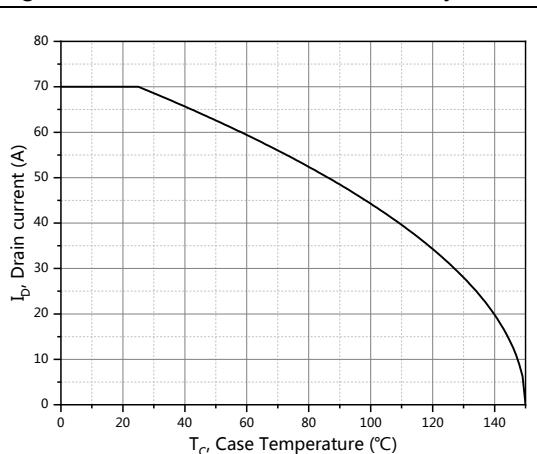


Figure 10, Drain current

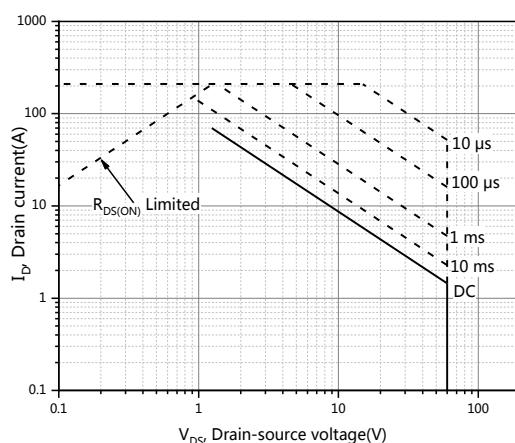
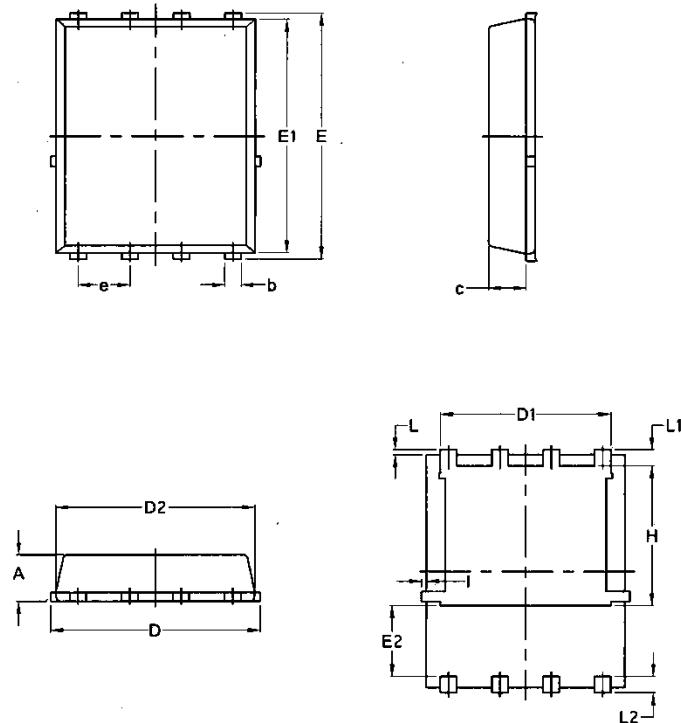


Figure 11, Safe operation area

Package Mechanical Data:DFN5x6-8L



Symbol	Common			
	mm		Inch	
	Mim	Max	Min	Max
A	1.03	1.17	0.0406	0.0461
b	0.34	0.48	0.0134	0.0189
c	0.824	0.0970	0.0324	0.082
D	4.80	5.40	0.1890	0.2126
D1	4.11	4.31	0.1618	0.1697
D2	4.80	5.00	0.1890	0.1969
E	5.95	6.15	0.2343	0.2421
E1	5.65	5.85	0.2224	0.2303
E2	1.60	/	0.0630	/
e	1.27 BSC		0.05 BSC	
L	0.05	0.25	0.0020	0.0098
L1	0.38	0.50	0.0150	0.0197
L2	0.38	0.50	0.0150	0.0197
H	3.30	3.50	0.1299	0.1378
I	/	0.18	/	0.0070